## 504687841 12/14/2017 PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMEN	Γ			
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT			
CONVEYING PARTY DA	ATA					
		Name			Execution Date	
TOMOYO FUTAKAWAM	IE				10/26/2017	
TOMOYUKI UEMURA				10/28/2017		
TAKU NAGASAWA					11/03/2017	
SHINOBU SASAKI					11/03/2017	
RECEIVING PARTY DA	 TA					
Name:		HONDA MOTOR CO., LTD.				
Street Address:	1-1, MINAMI-AOYAMA 2-CHOME, MINATO-KU					
City:	ТОКҮО					
State/Country:	JAPAN					
Postal Code:	107-8556					
Property Type		Number				
Application Number:		15567189				
CORRESPONDENCE D	ΑΤΑ					
Fax Number:	(	202)739-3001				
		the e-mail address first; if that is unsuccessful.				
using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail. Phone: 202.739.3000						
Email:	ŗ	patents@morganlewis.com, anne.sayles@morganlewis.com			lewis.com	
Correspondent Name:	F	ROBERT J. GAYBRICK				
Address Line 1:	-	1111 PENNSYLVANIA AVE NW				
Address Line 4:	١	WASHINGTON, D.C. 2000	)4			
ATTORNEY DOCKET NUMBER:		042715-5184	042715-5184			
NAME OF SUBMITTER:		JEFFREY G. KILLIA	JEFFREY G. KILLIAN			
SIGNATURE:		/Jeffrey G. Killian/				
DATE SIGNED:		12/14/2017				
Total Attachments: 2						

## **Total Attachments: 2**

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## ASSIGNMENT

WHEREAS WE, the below named inventors, (hereinafter referred to as "Assignors"), have made an invention entitled:

**SEAT** 

for which we file an application for United States Letters Patent, which is a National Stage application of International Application No. <u>PCT/JP2016/061844</u>, filed on <u>April 12, 2016</u>; and

WHEREAS HONDA MOTOR CO., LTD. whose post office address is 1-1, Minami-Aoyama 2-chome, Minato-ku Tokyo 107-8556 Japan (hereinafter referred to as "Assignee"), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Director of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, WE have hereunto set my hands.

Full Name of first Assignor	Тотоуо FUTAKAWAME
Address	c/o HONDA R&D CO., LTD., 1-4-1, Chuo, Wako-shi, Saitama 351-0193 Japan
Signature	Yomoloo Futakawame
Date	Somolyo Fitakawane OCT 26. 2017
Full Name of second Assignor	Tomoyuki UEMURA
Address	c/o HONDA R&D CO., LTD., 1-4-1, Chuo, Wako-shi, Saitama 351-0193 Japan
Signature	Tomaja 2 Ve anna 0C7. 28. 2017
Date	DCT. 28.2017

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PATENT REEL: 044397 FRAME: 0267

Full Name of third Assignor	Taku NAGASAWA	
Address	c/o HONDA R&D CO., LTD., 1-4-1, Chuo, Wako-shi, Saitama 351-0193 Japan	
Signature	Jaken Nagasawa	
Date	Nor 3 2017	
Full Name of fourth Assignor	Shinobu SASAKI	
Address	c/o HONDA R&D CO., LTD., 1-4-1, Chuo, Wako-shi, Saitama 351-0193 Japan	
Signature	Shinebu Susaki	
Date	Nov 3, 2017	

Morgan, Lewis & Bockius LLP